Notice of Allowability	Application No.	Applicant(s)		
	09/648,657	CHIKAMA ET AL.	CHIKAMA ET AL.	
	Examiner	Art Unit		
	Anita K Alanko	1765		
The MAILING DATE of this communication appearance All claims being allowable, PROSECUTION ON THE MERITS IS herewith (or previously mailed), a Notice of Allowance (PTOL-85) NOTICE OF ALLOWABILITY IS NOT A GRANT OF PATENT RI of the Office or upon petition by the applicant. See 37 CFR 1.313	(OR REMAINS) CLOSED in or other appropriate commu GHTS. This application is su	this application. If not included nication will be mailed in due co	urse. THIS	
1. X This communication is responsive to 3/10/04 amdt and 6/1	1/04 interview summary.	•		
2. ⊠ The allowed claim(s) is/are <u>1,2,4-9 and 11-15</u> .				
3. $igotimes$ The drawings filed on <u>25 August 2000</u> are accepted by the	Examiner.			
 4. Acknowledgment is made of a claim for foreign priority ur a) All b) Some* c) None of the: 1. Certified copies of the priority documents have 2. Certified copies of the priority documents have 3. Copies of the certified copies of the priority do International Bureau (PCT Rule 17.2(a)). * Certified copies not received: Applicant has THREE MONTHS FROM THE "MAILING DATE" noted below. Failure to timely comply will result in ABANDONM THIS THREE-MONTH PERIOD IS NOT EXTENDABLE. 	been received. been received in Application cuments have been received of this communication to file	n No in this national stage applicatio		
5. A SUBSTITUTE OATH OR DECLARATION must be subm INFORMAL PATENT APPLICATION (PTO-152) which give			TICE OF	
 6. CORRECTED DRAWINGS (as "replacement sheets") mus (a) including changes required by the Notice of Draftspers 1) hereto or 2) to Paper No./Mail Date (b) including changes required by the attached Examiner's Paper No./Mail Date Identifying indicia such as the application number (see 37 CFR 1 each sheet. Replacement sheet(s) should be labeled as such in the Total DEPOSIT OF and/or INFORMATION about the deposit attached Examiner's comment regarding REQUIREMENT 	son's Patent Drawing Review s Amendment / Comment or 84(c)) should be written on the header according to 37 CFI sit of BIOLOGICAL MATE	in the Office action of e drawings in the front (not the b R 1.121(d). ERIAL must be submitted. No		
Attachment(s) 1. Notice of References Cited (PTO-892) 2. Notice of Draftperson's Patent Drawing Review (PTO-948) 3. Information Disclosure Statements (PTO-1449 or PTO/SB/O Paper No./Mail Date 4. Examiner's Comment Regarding Requirement for Deposit of Biological Material	6. ⊠ Interview St Paper No./ 08), 7. ⊠ Examiner's	Formal Patent Application (PTO- ummary (PTO-413), Mail Date <u>0604</u> . Amendment/Comment Statement of Reasons for Allow - - Anita K Alanko Primary Examiner Art Unit: 1765	ance	

EXAMINER'S AMENDMENT

An examiner's amendment to the record appears below. Should the changes and/or additions be unacceptable to applicant, an amendment may be filed as provided by 37 CFR 1.312. To ensure consideration of such an amendment, it MUST be submitted no later than the payment of the issue fee.

Authorization for this examiner's amendment was given in a telephone interview with John Alexander on June 11, 2004.

Basis for this amendment can be found in the specification, for example, at page 11, lines 10-15.

The application has been amended as follows:

In the specification:

On page 14, line 18, after "Figs. 3A, 3B, 3C" insert -- and 3D --

In the claims:

Claim 1 (amended). A method for fabricating metal wirings, comprising the steps of:

forming a ground resin film by applying a resin onto an insulating substrate;

patterning the ground resin film; and

forming a low-resistance metal film <u>selectively</u> over the patterned ground resin film by a wet film formation technique wherein the patterned ground resin film is enclosed by the low-resistance metal film and the insulating substrate, wherein the low-resistance metal film is a single layer film containing any one of Cu, Ni, Sn, Au, Ag, Cr, or Pd or the low-resistance metal film is a multilayer film containing at least one single layer film containing Cu, Ni, or Au, thereby forming said metal wiring without using any etching technique.

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Cancel claim 16.

The following is an examiner's statement of reasons for allowance: the prior art does not teach or suggest a method for fabricating metal wirings, comprising the steps of:

forming a ground resin film by applying a resin onto an insulating substrate; patterning the ground resin film; and

forming a low-resistance metal film selectively over the patterned ground resin film by a wet film formation technique wherein the patterned ground resin film is enclosed by the low-resistance metal film and the insulating substrate, wherein the low-resistance metal film is a single layer film containing any one of Cu, Ni, Sn, Au, Ag, Cr, or Pd or the low-resistance metal film is a multilayer film containing at least one single layer film containing Cu, Ni, or Au, thereby forming said metal wiring without using any etching technique, as in the context of claim 1.

The closest prior art, Takada et al, discloses forming a metal film on a ground resin film, however the wiring is formed by etching, not without etching, as in the context of claim 1. There is no motivation to omit the etching step in Takada since it is required to form the final product.

Any comments considered necessary by applicant must be submitted no later than the payment of the issue fee and, to avoid processing delays, should preferably accompany the issue fee. Such submissions should be clearly labeled "Comments on Statement of Reasons for Allowance."

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Anita K Alanko whose telephone number is 571-272-1458. The examiner can normally be reached on Mon, Tues & Fri: 8:30 am-5 pm; Wed&Thurs:10 am-2 pm.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Nadine Norton can be reached on 571-272-1465. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Anita K Alanko Primary Examiner

Anta K. Hanko

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